



FAST RECOVERY
GLASS PASSIVATED BRIDGE RECTIFIER
Reverse Voltage:600Volts
Forward Current:15.0 Amps

FEATURES

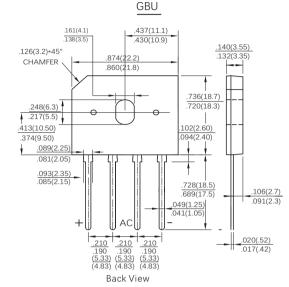
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- · Glass passivated chip junction
- · High current capability, Low forward voltage drop
- · Soft recovery improves EMC performance
- · High temperature soldering guaranteed:260°C/10 seconds at terminals
- · Component in accordance to RoHS 2015/863/EU

MECHANICAL DATA

- · Case: GBU molded plastic body
- Terminals: Plated leads solderable per MIL-STD-750,method 2026
- · Mounting Position: Anv

TYPICAL APPLICATIONS

Used in AC/DC bridge full wave rectification for SMPS, lighting ballaster, adapter, charger, home appliances, office equipment, and telecommunication applications.



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating at 25°C ambient temperature unless otherwise specified. Single phase ,half wave , resistive or inductive load. For capacitive load,derate current by 20%.)

Parameters		Symbol	EGBU1506	Units
Maximum Reverse Peak Reverse Voltage		V_{RRM}	600	Volts
Maximum RMS Voltage		V _{RMS}	420	Volts
Maximum DC Blocking Voltage		V_{DC}	600	Volts
Maximum Average Forward Rectified Current, (See Fig 2)		I _{F(AV)}	15.0	Amps
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load		I _{FSM}	180	Amps
Rating for Fusing (t =8.3ms)		l²t	134	A ² S
Maximum Instantaneous Forward Voltage at 7.5A DC		V _F	1.70	Volts
Maximum DC Reverse Current at rated DC blocking voltage	T,=25°C	I _R	5	μА
	T,=125℃		100	μΑ
Typical Junction Capacitance (Note 1)		C,	65	pF
Typical thermal resistance (Note 2) Junction-Ambient Junction-Case		$\begin{array}{c} R_{\scriptscriptstyle \theta JA} \\ R_{\scriptscriptstyle \theta JC} \end{array}$	25 1.8	°C/W
Maximum reverse recovery time(Note3)		trr	35	ns
Operating junction and storage temperature range		T) T stg	-55 to +150	°C

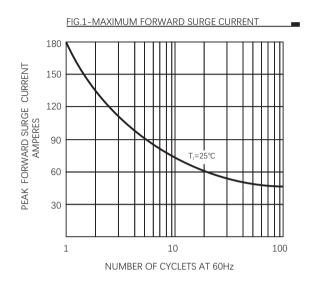
NOTE: 1.Measured at 1MHz and applied reverse voltage of 4.0 Volts.

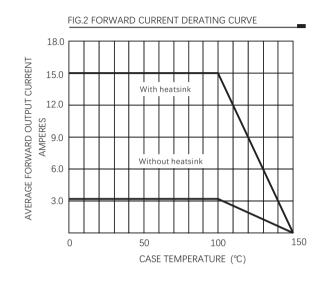
2 Unit mounted on 50mm x 50mm x 1.6mm copper plate heatsink

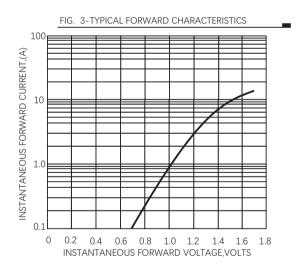
3.Test conditions: I_F=0.5A,I_R=1.0A,I_{RR}=0.25A.

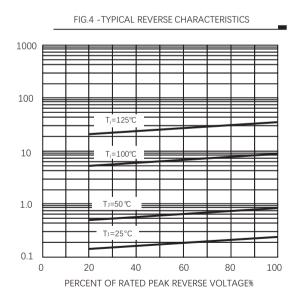
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